

April 2009

MOC256M AC Input Phototransistor Small Outline Surface Mount Optocouplers

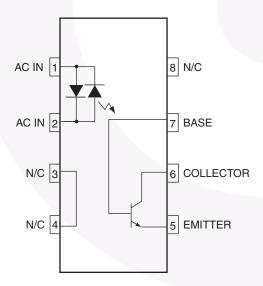
Features

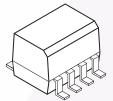
- UL recognized file (#E90700, Volume 2)
- VDE recognized (File #136616)
 - Ordering option V (i.e. MOC256VM)
- Industry standard SOIC-8 surface mountable package, with 0.050" lead spacing
- Available in tape and reel option
- Bidirectional AC input (protection against reversed DC bias)
- Guaranteed CTR symmetry of 2:1 maximum
- High input-output isolation of 2500 Vac (rms) guaranteed

Description

The MOC256M is an AC input phototransistor optocoupler. The device consists of two infrared emitters connected in anti-parallel and coupled to a silicon NPN phototransistor detector. It is designed for applications requiring the detection or monitoring of AC signals. The device is constructed with a standard SOIC-8 footprint.

Schematic





©2005 Fairchild Semiconductor Corporation MOC256M Rev. 1.0.1

Absolute Maximum Ratings (T_A = 25°C Unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Rating	Value	Unit	
EMITTER				
I _F	Forward Current – Continuous	60	mA	
I _F (pk)	Forward Current – Peak (PW = 100µs, 120 pps)	1.0	А	
P _D	LED Power Dissipation @ T _A = 25°C	90	mW	
	Derate above 25°C	0.8	mW/°C	
DETECTOR				
V _{CEO}	Collector-Emitter Voltage	30	V	
V _{ECO}	Emitter-Base Voltage	7.0	V	
I _C	Collector Current-Continuous	150	mA	
P _D	Detector Power Dissipation @ T _A = 25°C	150	mW	
	Derate above 25°C	1.76	mW/°C	
TOTAL DEVICE				
V _{ISO}	Input-Output Isolation Voltage (f = 60Hz, t = 1 min.)	2500	Vac(rms)	
P _D	Total Device Power Dissipation @ T _A = 25°C	250	mW	
	Derate above 25°C	2.94	mW/°C	
T _A	Ambient Operating Temperature Range	-40 to +100	°C	
T _{stg}	Storage Temperature Range	-40 to +150	°C	

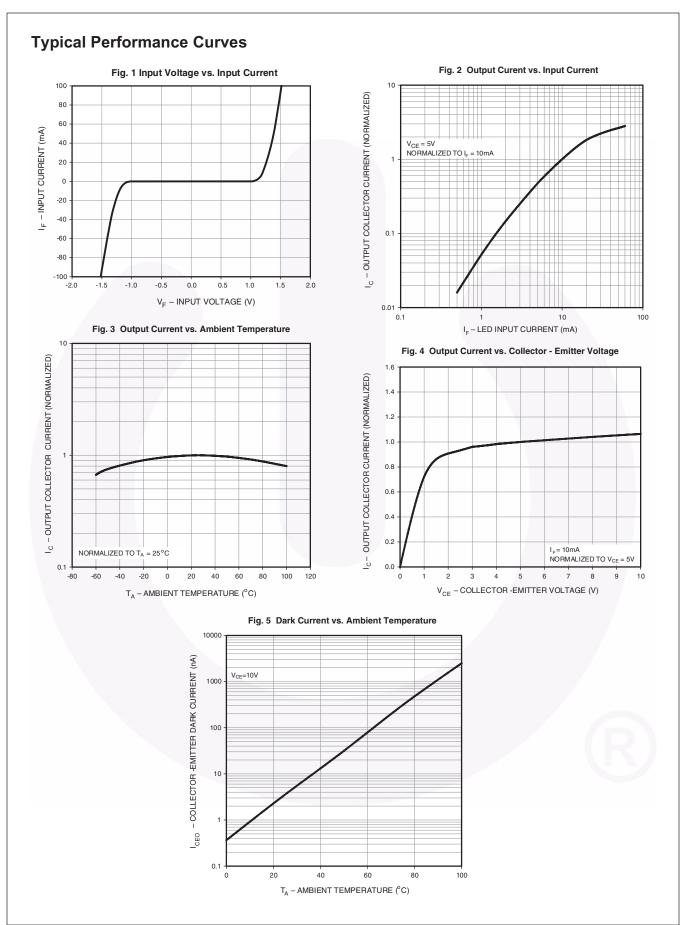
Electrical Characteristics ($T_A = 25$ °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.*	Max.	Unit
EMITTER			ı			
V _F	Input Forward Voltage	$I_F = \pm 10 \text{mA}$		1.2	1.5	V
CJ	Input Capacitance	V = 0 V, f = 1MHz		20		pF
DETECTO	R				•	
I _{CEO1}	Collector-Emitter Dark Current	V _{CE} = 10V, T _A = 25°C		1.0	100	nA
I _{CEO2}		V _{CE} = 10V, T _A = 100°C		1.0		μA
I _{CBO}	Collector-Base Dark Current	V _{CB} = 10V		0.2		nA
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = 10mA	30	100		nA
BV _{CBO}	Collector-Base Breakdown Voltage	I _C = 100μA	70	120		V
BV _{ECO}	Emitter-Collector Breakdown Voltage	I _E = 100μA	5	10		V
C _{CE}	Collector-Emitter Capacitance	f = 1.0MHz, V _{CE} = 0		7		pF
C _{CB}	Collector-Base Capacitance	f = 1.0MHz, V _{CB} = 0		20		pF
C _{EB}	Emitter-Base Capacitance	f = 1.0MHz, V _{EB} = 0		10		pF
COUPLED						
CTR	Current Transfer Ratio ⁽¹⁾	$I_F = \pm 10 \text{mA}, V_{CE} = 10 \text{V}$	20	150		%
	Output-Collector Current Symmetry	$I_{C} @ I_{F} = +10\text{mA}, V_{CE} = 10V$ $I_{C} @ I_{F} = -10\text{mA}, V_{CE} = 10V$	0.5		2.0	
V _{CE (sat)}	Collector-Emitter Saturation Voltage	$I_C = 0.5 \text{mA}, I_F = \pm 10 \text{mA}$		0.1	0.4	V
V _{ISO}	Isolation Surge Voltage ⁽²⁾⁽³⁾	f = 60Hz AC Peak, t = min.	2500			Vac(rms)
R _{ISO}	Isolation Resistance ⁽³⁾	V = 500V	10 ¹¹			Ω
C _{ISO}	Isolation Capacitance ⁽³⁾	V = 0V, f = 1MHz	_	0.2		pF

^{*} Typical values at T_A = 25°C

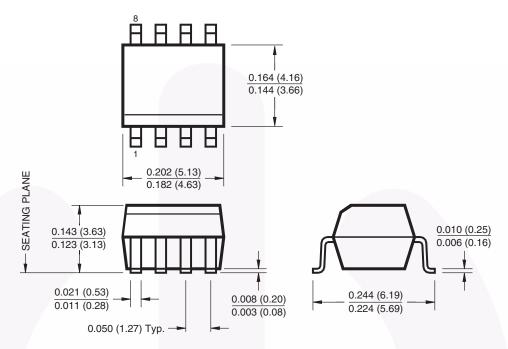
Notes:

- 1. Current Transfer Ratio (CTR) = $I_C/I_F \times 100\%$.
- 2. Isolation Surge Voltage, $V_{\mbox{\scriptsize ISO}}$, is an internal device dielectric breakdown rating.
- 3. For this test, Pins 1 and 2 are common and Pins 5, 6 and 7 are common.



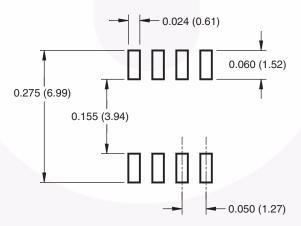
Package Dimensions

8-pin SOIC Surface Mount



Lead Coplanarity: 0.004 (0.10) MAX

Recommended Pad Layout



Dimensions in inches (mm).

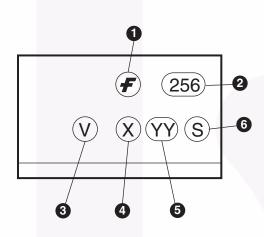
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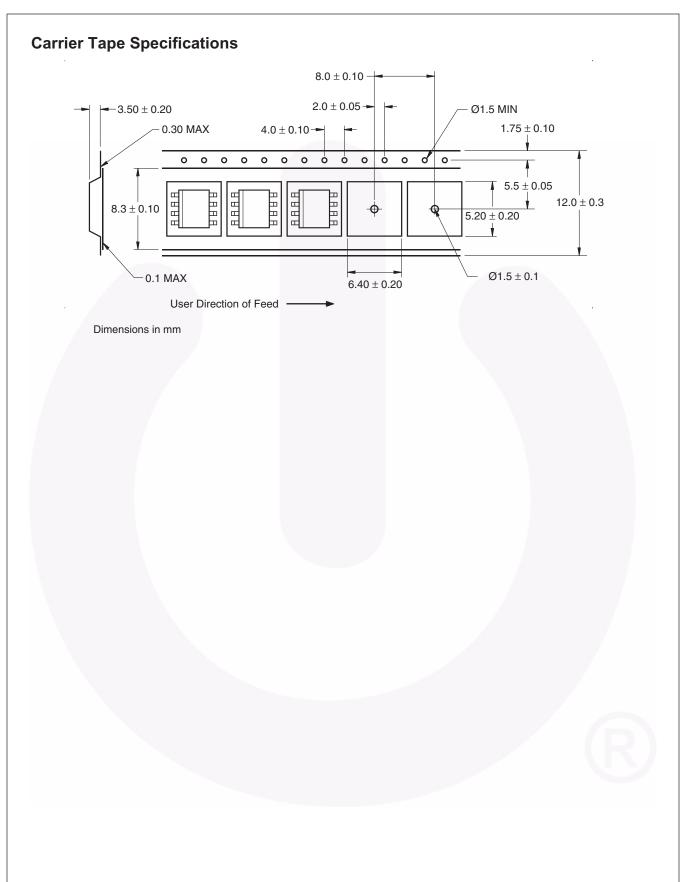
Ordering Information

Option	Order Entry Identifier	Description	
V	V	VDE 0884	
R2	R2	Tape and reel (2500 units per reel)	
R2V	R2V	VDE 0884, Tape and reel (2500 units per reel)	

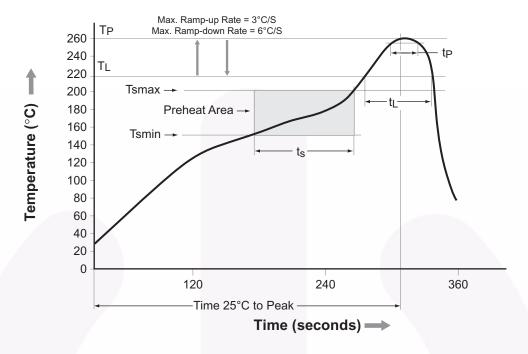
Marking Information



Defini	tions	
1	Fairchild logo	
2	Device number	
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)	
4	One digit year code, e.g., '8'	
5	Two digit work week ranging from '01' to '53'	
6	Assembly package code	



Reflow Profile



Profile Freature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (t _S) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t _L to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60-150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.





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Datasheet Identification	Product Status	Definition	
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.	
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.	
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